Docket No.

268844US0PC

28 JUN 2005

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF:

Hiroshi SHIHO, et al.

SERIAL NO:

10/529,742

GAU:

FILED:

March 29, 2005

**EXAMINER:** 

FOR:

POLISHING PAD FOR SEMICONDUCTOR WAFER AND LAMINATED BODY FOR POLISHING OF SEMICONDUCTOR WAFER EQUIPPED WITH THE SAME AS WELL AS METHOD FOR POLISHING OF

SEMICONDUCTOR WAFER

## **INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR 1.97**

COMMISSIONER FOR PATENTS ALEXANDRIA, VIRGINIA 22313

SIR

Applicant(s) wish to disclose the following information.

### REFERENCES

The applicant(s) wish to make of record the references listed on the attached form PTO-1449. Copies of the listed references are attached, where required, as are either statements of relevancy or any readily available English translations of pertinent portions of any non-English language references.

☐ A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

#### RELATED CASES

Attached is a list of applicant's pending application(s), published application(s) or issued patent(s) which may be related to the present application. In accordance with the waiver of 37 CFR 1.98 dated September 21, 2004, copies of the cited pending applications are not provided. Cited published and/or issued patents, if any, are listed on the attached PTO form 1449.

☐ A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

#### CERTIFICATION

- Each item of information contained in this information disclosure statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this statement.
- □ No item of information contained in this information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application or, to the knowledge of the undersigned, having made reasonable inquiry, was known to any individual designated in 37 CFR §1.56(c) more than three months prior to the filing of this statement.

### **DEPOSIT ACCOUNT**

Please charge any additional fees for the papers being filed herewith and for which no check or credit card payment is enclosed herewith, or credit any overpayment to deposit account number 15-0030. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

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Customer Number

22850

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Form PTO 1449	U.S. DEPARTMENT OF COMMERCE			ATTY DOCKET NO.		SERIAL NO.		
(Modified) PATENT AND TRADEMARK OFFICE			268844US0PCT	10/529,742				
				APPLICANT				
LIST OF	REFE	RENCES CITED BY AP	PLICANT	Hiroshi SHIHO, et al.				
۳,				FILING DATE	GROUP			
				March 29, 2005				
				U.S. PATENT DOCUMENTS		<u> </u>		
EXAMINER		DOCUMENT	1		T	SUB	FI	LING DATE
INITIAL		NUMBER	DATE	NAME	CLASS	CLASS IF APPROPRIATE		
	AA	2004/0118051	06/24/04	SHIHO et al.				-
	AB	2004/0203320	10/14/04	HOSAKA et al.				
	AC	2004/0224616	11/11/04	SHIHO et al.				
	AD	2005/0014376	01/20/05	SHIHO et al.				<del> </del>
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			FO	REIGN PATENT DOCUMENTS				
		DOCUMENT	T			TRANSLATION		
		NUMBER	DATE	COUNTRY	P (with English abstract & equivalent of US 190234)		YES NO	
	AO	9-7985	01/10/97	JP (with English abstract & equivalent ( 5964643)				NO
	AP	2000-326220	11/28/00	6190234)				NO
	AQ	11-512977	11/09/99	JP (with English abstract & equivalent ( 97/06921)	of WO			NO
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	AS							
	AT							
	ΑU							
	ΑV							
		OTHER RI	FERENCES (	Including Author, Title, Date, Pertinen	t Pages, e	tc.)		
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	AZ				Addi	tional Refe	rences s	heet(s) attached
Examiner					Date Cor	Date Considered		
*Examiner: In	itial if r	eference is considered,	whether or not	t citation is in conformance with MPEP 6	09; Draw lii	ne through	citation	f not in
conformance	and no	ot considered. Include co	opy of this form	with next communication to applicant.				

U.S. PCT Application Serial No.: 10/529,742 Docket No.: <u>268844US0PCT</u>

# STATEMENT OF RELEVANCY

these		ave been cited in the International Search Resubmitted herewith only when not automationing Authority.	
2) R A co <sub>j</sub>	References py of these references	have been cited in the corresponding is being submitted herewith.	Search Report.
	References <u>AO-AC</u> ences is being submitt	2 are discussed in the specification. A cotted here with.	opy of these
	References	_ are additional prior art known to Applicant ubmitted herewith.	A copy of

# **LIST OF RELATED CASES**

Docket Number	Serial or Patent Number	Filing or <u>Issue Date</u>	Patent Appl.  Publication No.	Inventor/ Applicant
244894US0	10/700,554	11/05/03	US2004/0118051 A1	SHIHO, et al.
251598US0	10/820,123	04/08/04	US2004/0203320 A1	HOSAKA, et al.
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271553US0	11/115,122	04/27/05		HOSAKA, et

<sup>\*</sup>Present Application; listed for information NFO/amr